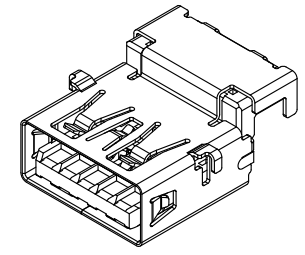
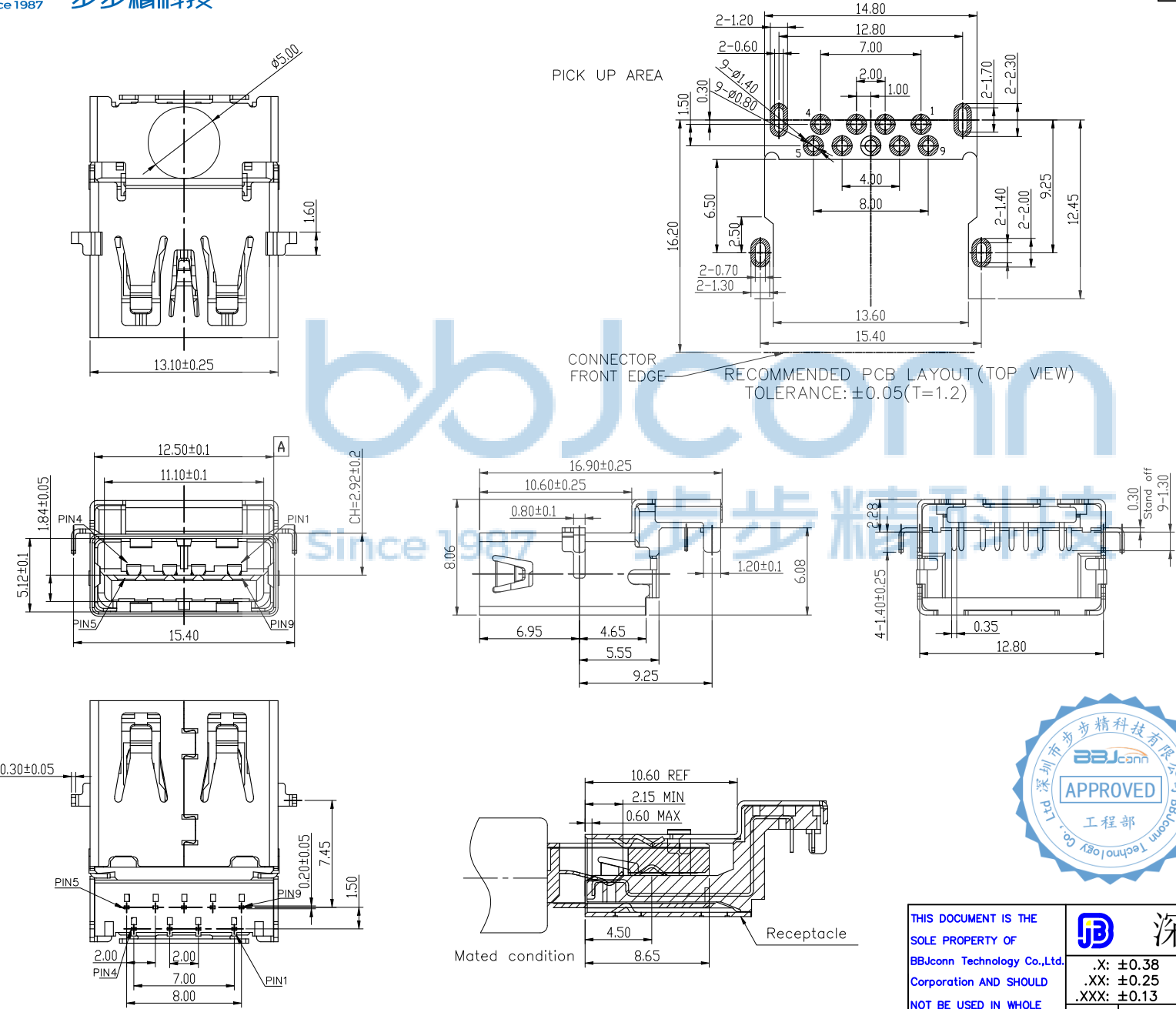
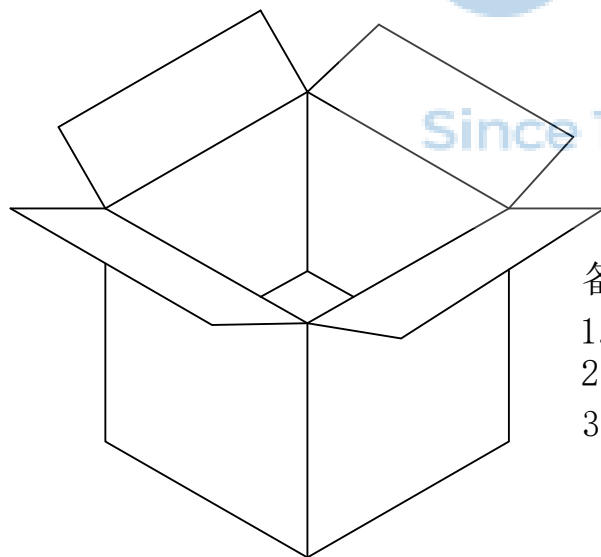
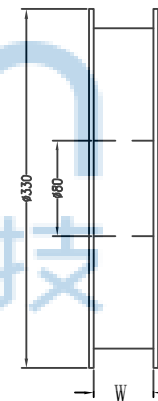
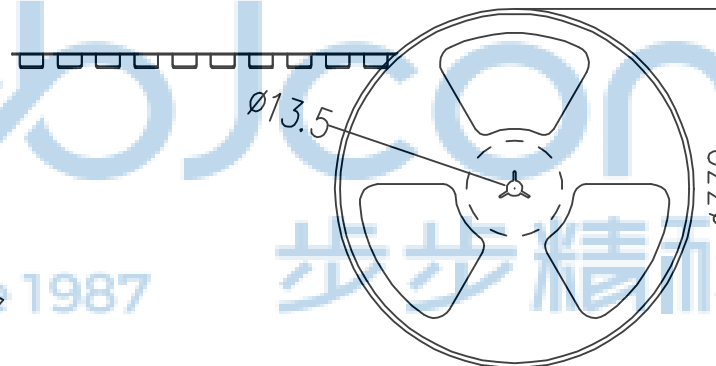
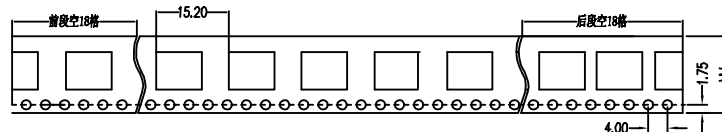
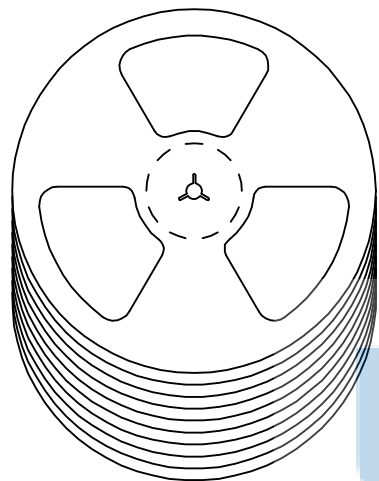


REV.	ECN NO.	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF

NOTE:
 1. MATERIAL:
 1.1 INSULATOR: HIGH TEMPERATURE PLASTIC UL 94 V-0;BLACK (PA9T)
 1.2 CONTACT: C2680
 1.3 SHELL:SUS 304
 2. ELECTRICAL CHARACTERISTICS:
 2.1 CONTACT RESISTANCE: 30mΩ MAX
 2.2 CONTACT CURRENT RATING: 1.8A (PIN 1, 4) ; OTHER CONTACTS 0.25A
 2.3 DIELECTRIC WITHSTANDING VOLTAGE: 500 V R.M.S.
 2.4 INSULATION RESISTANCE 100 MΩ MIN
 2.5 OPERATING TEMPERATURE: -40° C ~ 85° C
 3. MECHANICAL CHARACTERISTICS:
 3.1 MATING FORCE: 3.57 kgf MAX.
 3.2 REMOVAL FORCE: 1.0 kgf Min
 3.3 DURABILITY: MANDATORY: 5,000 CYCLES
 3.4. SALT SPRAY 48HR PASS.
 4.1 TERMINAL:
 50u" MIN NICKEL (CONTACT AREA) 100u" MIN Tin ON SOLDER AREA (1~30)u" Au ON CONTACT AREA
 4.2 SHELL: 60u" MIN. NICEL



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PDWG.NO: 0536-1	DR. SGF	.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3° .X': ±2° .XX': ±1°
APPD. JM_Zheng	CHKD. LYX	NAME: USB 3.1 AF 90度 外壳四脚DIP 端子DIP 反向沉板6.08 L=16.90 CH=2.92 脚距15.4 平口 不锈钢外壳 镀金足1u 编带	
FINISH: SEE NOTES		MAT'L.: SEE NOTES	
SCALE: N/A		REV.: A0	UNIT: mm PAGE: 1/2



备注:

1. 包装数量: 400/PCS/卷, 10卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
 载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
 上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
 卷盘: 聚苯乙烯。

纸箱规格: 345*345*230MM
 纸箱规格: 345*345*350MM

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.X: ± 0.38 .XX: ± 0.25 .XXX: ± 0.13 X': $\pm 3^*$.X': $\pm 2^*$.XX': $\pm 1^*$		NAME: USB 3.1 AF 90度 外壳四脚DIP 端子DIP 反向沉板6.08 L=16.90 CH=2.92 脚距15.4 平口 不锈钢外壳 镀金足1u 编带	
APPD.	JM_Zheng	PJ. NO.:	
CHKD.	LYX	SIZE: A4 DRW NO.:	
DR.	SGF	FINISH: SEE NOTES	MAT'L.: SEE NOTES
PDWG NO:	0536-1	SCALE: N/A	REV.: A0 UNIT: mm PAGE: 2/2